



PCB
LOGO
Logo1

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Orderable: ChangeMe!	Designed for: Public Release	Mod. Date: 3/28/2017
TID #: TIDA-00998_CT_EHS	Project Title: Fault Indicator Using TPS61098	
Number: TIDA-00998_CIR_EHS E1	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By:	File: TIDA-00998_CT_EHS_E1_BlankSheet.SchDoc	Size: A4
Engineer: Jasper Li	Contact: http://www.ti.com/support	





PCB Number: TIDA-00998_CT_EHS
PCB Rev: E1

PCB LOGO
Texas Instruments

PCB LOGO
Pb-Free Symbol

Variant/Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

LBL1

PCB Label

Size: 0.65" x 0.20"

ZZ1

Label Assembly Note

This Assembly Note is for PCB labels only

ZZ2

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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